

**AMENDMENTS TO THE CLAIMS**

**This listing of claims will replace all prior versions and listings of claims in the application:**

**LISTING OF CLAIMS:**

1. (original): A heat-decaying material comprising a polyoxyalkylene resin as the principal ingredient thereof, which has an oxygen atom content of from 15 to 55 % by mass and of which at least 95 % by weight decays within 10 minutes when heated at a predetermined temperature falling between 150 and 350°C.
2. (original): The heat-decaying material as claimed in claim 1, wherein the polyoxyalkylene resin is polyoxypolypropylene, polyoxyethylene, polyoxytetramethylene, or a mixed resin of polyoxypolypropylene, polyoxyethylene and/or polyoxytetramethylene.
3. (original): The heat-decaying material as claimed in claim 2, wherein the polyoxypolypropylene content of the mixed resin is at least 50 % by mass.
4. (currently amended): The heat-decaying material as claimed in ~~any of~~ claim 1-to-claim 3, wherein the polyoxyalkylene resin has a number-average molecular weight of from 500 to 5,000,000.
5. (currently amended): The heat-decaying material as claimed in ~~any of~~ claim 1-to-claim 4, which contains a decomposition promoter.
6. (original): The heat-decaying material as claimed in claim 5, wherein the decomposition promoter is a peroxide.
7. (original): The heat-decaying material as claimed in claim 5, wherein the decomposition promoter is an azo compound.

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8. (original): The heat-decaying material as claimed in claim 5, wherein the decomposition promoter is tin oxide.
9. (currently amended): The heat-decaying material as claimed in ~~any of~~ claim 1 to ~~claim~~ 4, which contains a decomposition retardant.
10. (original): The heat-decaying material as claimed in claim 9, wherein the decomposition retardant is any of a mercapto compound, an amine compound, an organic tin, or an organic boron.
11. (currently amended): The heat-decaying material as claimed in ~~any of~~ claim 1 to ~~claim~~ 10, which decays when heated in an oxygen-containing atmosphere at a predetermined temperature falling between 150 and 300°C.
12. (currently amended): The heat-decaying material as claimed in ~~any of~~ claim 1 to ~~claim~~ 10, which decays when heated in an anaerobic atmosphere at a predetermined temperature falling between 150 and 350°C.
13. (currently amended): The heat-decaying material as claimed in ~~any of~~ claim 1 to ~~claim~~ 12, which decays when heated under reduced pressure within 5 minutes at a predetermined temperature falling between 150 and 350°C.
14. (currently amended): A heat-decaying material of a heat-decaying sheet which is composed of the heat-decaying material of ~~any of~~ claim 1 to ~~claim~~ 13 and which keeps its sheet form at a temperature of 100°C or lower.

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15. (original): The heat-decaying material as claimed in claim 14, wherein the polyoxyalkylene resin is not crosslinked and has a number-average molecular weight of from 5000 to 5,000,000.

16. (original): The heat-decaying material as claimed in claim 14, wherein the heat-decaying sheet contains a crosslinked polyoxyalkylene resin.

17. (original): The heat-decaying material as claimed in claim 16, wherein the crosslinked polyoxyalkylene resin is formed by crosslinking a crosslinkable functional group-having polymer that contains segments of a crosslinkable functional group-having polyalkylene glycol or polyoxyalkylene, with a crosslinking agent.

18. (original): The heat-decaying material as claimed in claim 14, wherein the heat-decaying sheet contains an uncrosslinked polymer that contains segments of an uncrosslinked polyalkylene glycol or polyoxyalkylene.

19. (currently amended): The heat-decaying material as claimed in ~~any of~~ claim 14 to ~~claim 18~~, wherein the heat-decaying sheet is reinforced with a substrate.

20. (currently amended): A heat-decaying material comprising the heat-decaying material of ~~any of~~ claim 1 to ~~claim 13~~, which contains a crosslinkable functional group-having polymer that contains segments of a crosslinkable functional group-having polyoxyalkylene glycol or polyoxyalkylene, and a crosslinking agent, and which has a viscosity at 20°C of from 1 to 5,000,000 mPa·s.

21. (original): The heat-decaying material as claimed in claim 20, which contains at most 30 % by mass of a polymerizable unsaturated group-having compound.

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22. (original): The heat-decaying material as claimed in claim 20, which has a viscosity at 20°C of from 1 to 100 mPa·s.
23. (original): The heat-decaying material as claimed in claim 20, which has a viscosity at 20°C of from 500 to 100,000 mPa·s.
24. (original): The heat-decaying material as claimed in claim 20, which has a viscosity at 20°C of from 20 to 1000 mPa·s.
25. (original): The heat-decaying material as claimed in claim 17 ~~or claim 20~~, wherein the crosslinkable functional group is at least one selected from a hydrolyzing silyl group, an isocyanate group, an epoxy group, an oxetanyl group, an acid anhydride group, a carboxyl group, a hydroxyl group, and a polymerizable unsaturated hydrocarbon group.
26. (currently amended): The heat-decaying material as claimed in ~~any of~~ claim 14 ~~to~~ claim 19, which decays in a temperature atmosphere falling between 150 and 220°C.
27. (currently amended): The heat-decaying material as claimed in ~~any of~~ claim 14 ~~to~~ claim 19, which decays in a temperature atmosphere falling between 220 and 280°C.
28. (currently amended): The heat-decaying material as claimed in ~~any of~~ claim 14 ~~to~~ claim 19, which decays in a temperature atmosphere falling between 280 and 350°C.
29. (currently amended): The heat-decaying material as claimed in ~~any of~~ claim 20 ~~to~~ claim 24, wherein the cured product of the material decays in a temperature atmosphere falling between 150 and 220°C.

30. (currently amended): The heat-decaying material as claimed in ~~any of~~ claim 20 to ~~claim~~ 24, wherein the cured product of the material decays in a temperature atmosphere falling between 220 and 280°C.

31. (currently amended): The heat-decaying material as claimed in ~~any of~~ claim 20 to ~~claim~~ 24, wherein the cured product of the material decays in a temperature atmosphere falling between 280 and 350°C.

32. (original): A method for producing a porous material, which comprises:

a step of preparing a precursor that contains a skeleton-forming crosslinkable material (a) and the heat-decaying material (b) of claim 1 that comprises a polyoxyalkylene resin as the principal ingredient thereof and decomposes and evaporates when heated;

a step of heating the precursor at a temperature not lower than the temperature at which the heat-decaying material (b) decays under heat;

a step of crosslinking the crosslinkable material before or during the heating to form a skeleton phase,

and in which the heat-decaying material (b) decays in the crosslinked material to give a porous material having a large number of pores surrounded by the skeleton phase.

33. (original): A transfer sheet constructed by adhering a transfer object on a heat-decaying adhesive resin layer that comprises the heat-decaying material of claim 1.

34. (original): A patterning method, which comprises a step of forming a heat-decaying resin film of the heat-decaying material of claim 1 on the surface of a substrate to be processed,

and a step of selectively applying thermal energy to the heat-decaying resin film so as to decay the heat-decaying resin film in the thermal energy-irradiated area to thereby form a pattern of the heat-decaying resin film.

35. (original): A patterning method, which comprises:

a step of forming a heat-decaying resin film of the heat-decaying material of claim 1 on the surface of a substrate to be processed;

a step of transferring a pattern formed in a photomask to the heat-decaying resin material through exposure of the material to light; and

a step of heating the heat-decaying resin film after the exposure transfer step for selectively decaying the heat-decaying resin film in the region not exposed to light in the previous exposure transfer step to thereby form a pattern of the heat-decaying resin film.

36. (new): The heat-decaying material as claimed in claim 20, wherein the crosslinkable functional group is at least one selected from a hydrolyzing silyl group, an isocyanate group, an epoxy group, an oxetanyl group, an acid anhydride group, a carboxyl group, a hydroxyl group, and a polymerizable unsaturated hydrocarbon group.